Access to ESA funded developments

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ITTs for Space Thermal Engineering Tools

• Reminder: All* new developments are supported by Open Tenders, openly published at http://emits.esa.int
  – There were currently 2 ITTs open:
    • Thermal Concept Design Tool
    • ESATAP
• We do not advertise new ITTs via mailing lists in order to promote fair competition. It is up to you to look for business opportunities.
  – For example, all companies who had questions are already registered on EMITS and have the same level of information as any other bidder.

* Except when direct negotiation is justified, and this is rarely the case (used for existing products, very short time frame, etc)
**TOS-MCV “planned” R&D (GSP, TRP, GSTP)**

- Preliminary comment: as indicated by Hans Peter, the work on harmonisation/OSS is pretty much at the feasibility stage. So far:
  - One contract has been awarded
  - Within the frame of GSP
  - Does not affect our support for other tools, e.g. ESARAD/ESATAN
- TRP 2004-2004 and GSTP-4 are in preparation
  - Users and ESA projects have been consulted
  - 17 TOS-MCV proposals (4 linked to harmonisation)
  - Majority are GSTP
  - Waiting for TRP/GSTP board decision
  - Do not yet know which activities will be endorsed

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**TOS-MCV Mailing Lists**

- Used for:
  - ICES
  - Workshop
  - TASverter
  - Harmonisation
- Approximately 200 e-mail addresses
  - Participants of previous workshops
  - People who replied to the harmonisation user survey, etc.
  - Includes 3 people from one of the companies with questions for example
- If you would like to be on our mailing list, please let us know!

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**17th European Thermal and ECLS Software Workshop**

**21-22 October 2003**

**Sheet 3**